IEEE研究指南:學術搜索、文 獻調研、科研投稿及職涯發展



Agenda: How does IEEE can help?

Idea (No Idea)

Course work

Research

Publish /Patent

Career Dev





IEEE Intro





The Institute of Electrical and Electronics Engineers



IEEE members are the technology leaders of today and tomorrow

IEEE Medal of Honor Recipients

2013

Irwin Jacobs

Co-Founder Qualcomm Inc



2014

B. Jayant Baliga

Transformed Power Semiconductors



2015

Mildred Dresselhaus

Paved the way for the rise of Nanotechnology

2016

G. David Forney, Jr.

Launched a Million Modems







Today' s IEEE

Our Global Reach

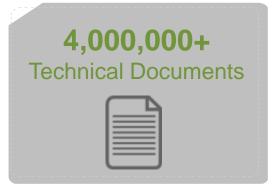


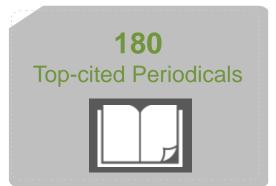




Our Technical Breadth









- IEEE Aerospace and Electronic Systems Society
- IEEE Antennas and Propagation Society
- IEEE Broadcast Technology Society
- IEEE Circuits and Systems Society
- IEEE Communications Society
- IEEE Components, Packaging, and
 - Manufacturin
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- **IEEE Education Society**
- IEEE Electron Devices Society
- IEEE Electromagnetic Compatibility Society
 - IEEE Engineering in Medicine and Biology Society
- IEEE Geoscience and Remote Sensing Society
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- IEEE Photonics Society
- IEEE Power Electronics Society
- IEEE Power & Energy Society

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of

39 IEEE Societies

- IEEE Systems, Man, and Cybernetics Society
- IEEE Technology and Engineering Management Society
- IEEE Ultrasonics, Ferroelectrics, and Frequency Control Society
- IEEE Vehicular Technology Society



IEEE Covers All Areas of Technology More than just electrical engineering & computer science

- Aerospace & Defense
- Automotive Engineering
- Biomedical Engineering
- Biometrics
- Circuits & Systems
- Cloud Computing
- Communications
- Computer Software
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- Engineering
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- Information Technology
- Medical Devices
- Nanotechnology
- Optics
- Petroleum & Gas
- Power Electronics
- Power Systems
- Robotics & Automation
- Semiconductors
- Smart Grid
- Wireless Broadband and many more



How does IEEE Xplore can help?

Idea (No Idea)

Course work

Research

Publish /Patent

Career Dev

- Knowledge of the field
 - Technology trends
 - Top researchers
 - Top affiliations
 - Top journals
 - Top conferences

- Key papers
 - Codes
 - Datasets
 - •Multimedia
 - . . .



• . . .

The importance of literature review

IEEE peer review criteria

- Content: Content that is appropriate, in scope and level
- **Originality**: Clearly written original material that addresses a new and important problem
- Extension Work: Extension of previously published work
- Validity: Valid methods and rationale
- Good Illustrations, tables and graphs that support the text
- References: References that are current and relevant to the subject



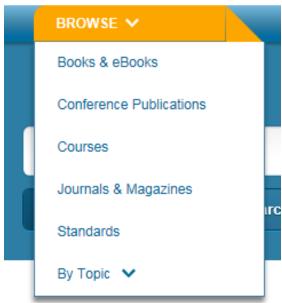
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 43 VDE conferences
- More than 2800 IEEE standards
 (active, archived. redlines) + IEEE

 Standard Dictionary
- 20 IET conferences, 26 IET journals & magazines
- Bell Labs Technical Journal (BLTJ) back to 1922
- Backfile to 1988, select legacy data back to 1872

- Technical Books
- Educational Courses









From IEEE Xplore: 8774 results

- Transparency service model for data security in cloud computing
- •Comparative study of different cryptographic algorithms for data security in cloud computing
- Ensuring data storage security in cloud computing based on hybrid encryption schemes



First Steps

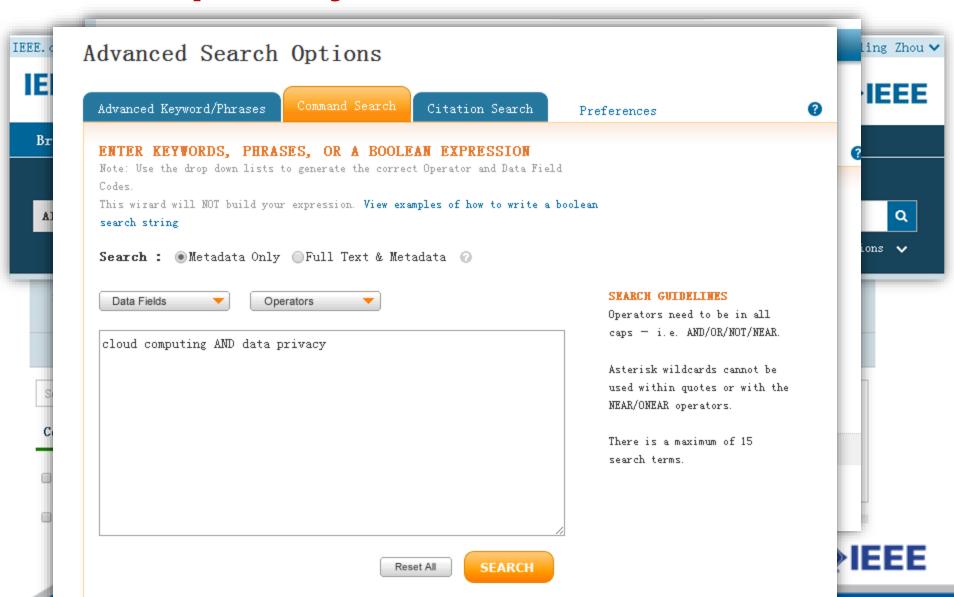
Your research problem must contribute new and important knowledge to your field

- Conduct a Literature Review
- Gather References & Citations
- Take Notes & Keep Track

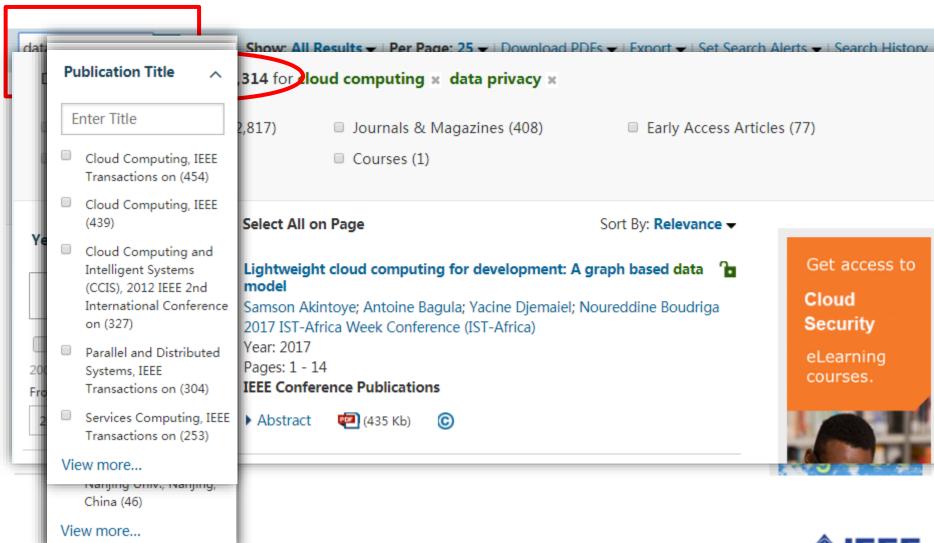




Multiple ways to start a search



Start broad, narrow down





Identify most cited papers

Displaying results 1-25 of 3,314 for cloud computing * data privacy *

- Conference Publications (2,817)
- Journals & Magazines (408)
- Early Access Articles (77)

■ Books & eBooks (11)

Courses (1)



Select All on Page

Lightweight cloud computing for developmen model

Samson Akintoye; Antoine Bagula; Yacine Djen 2017 IST-Africa Week Conference (IST-Africa)

Year: 2017 Pages: 1 - 14

IEEE Conference Publications

Abstract





A Security Model for Preserving the Privacy of Medical Big Data in a Healthcare Cloud Using a Fog Computing Facility With Pairing-Based Cryptography

Hadeal Abdulaziz Al Hamid; Sk Md Mizanur Rahman; M. Shamim Hossain; Ahmad Almogren; Atif Alamri IEEE Access



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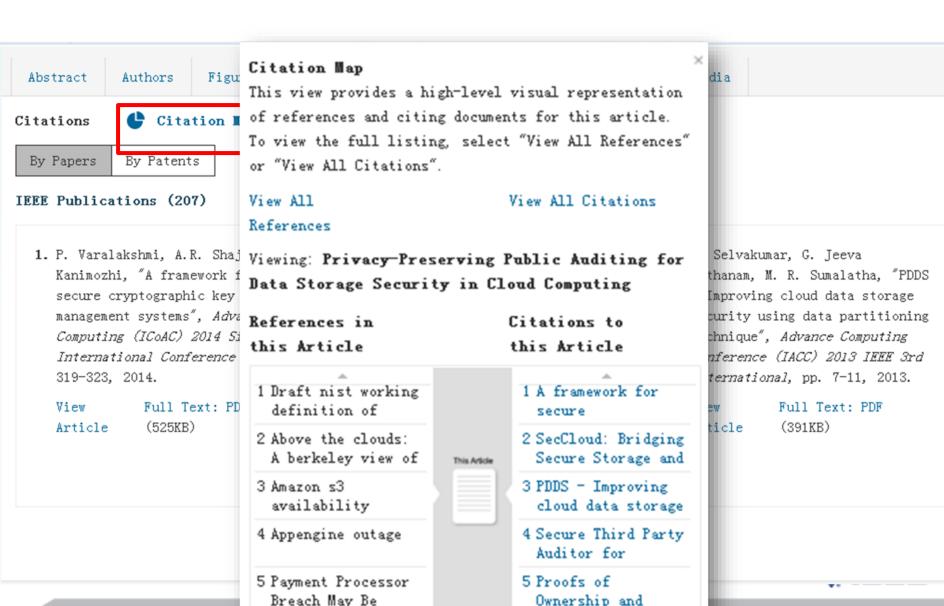


Follow the lead, deep dive

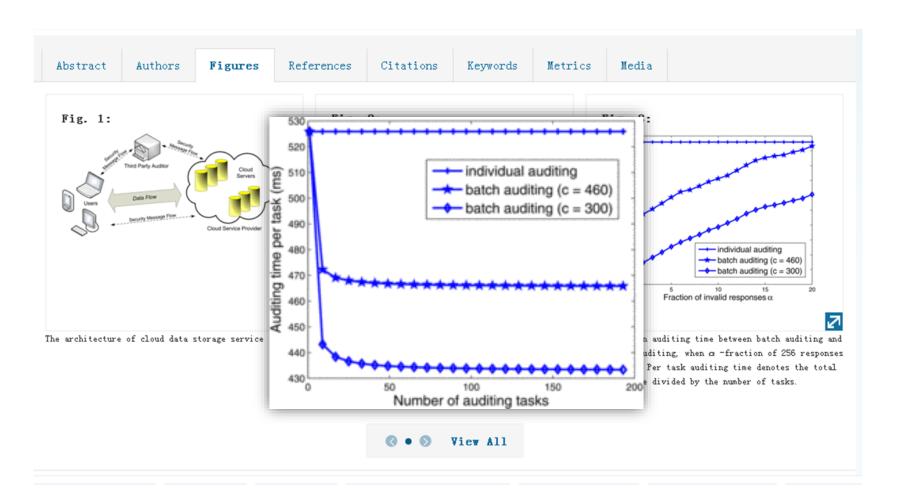




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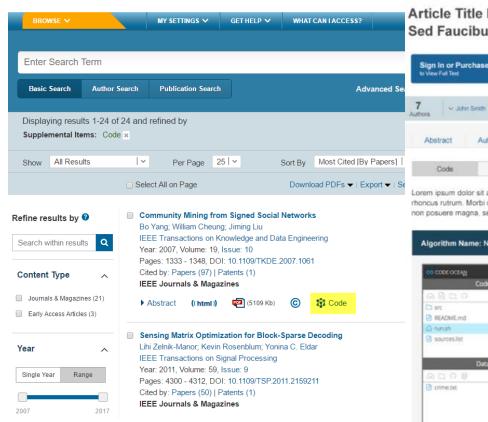




View code&datasets







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Article 2 Endssportior endiss sodders vitae...

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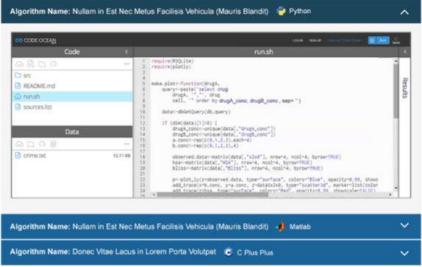
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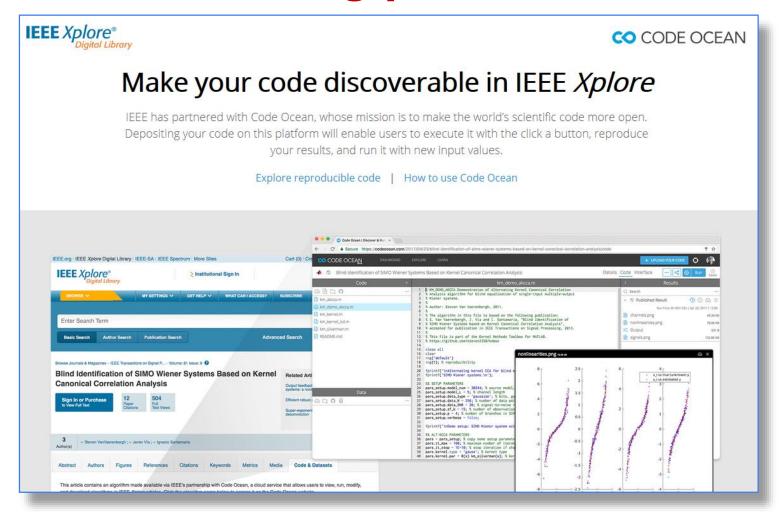
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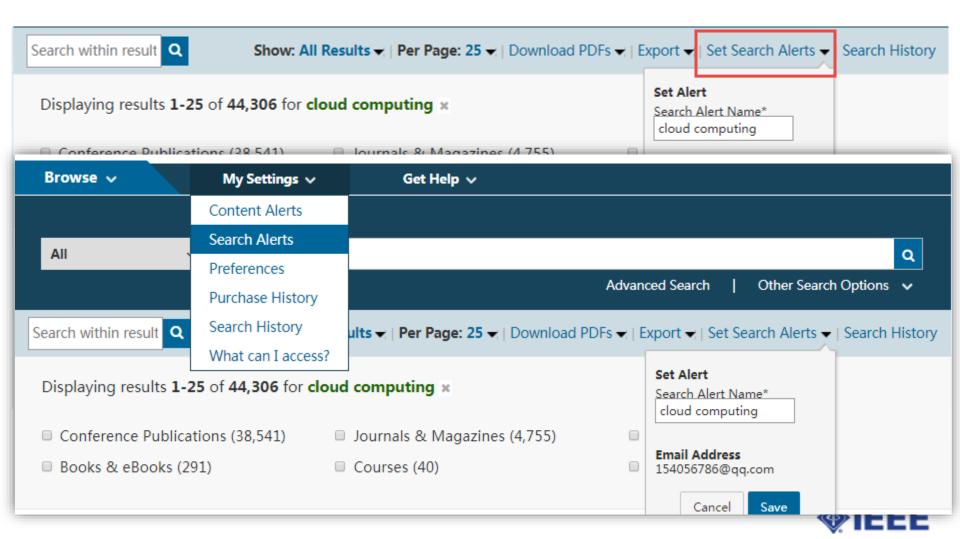
IEEE code sharing platform



https://codeocean.com/signup/ieee

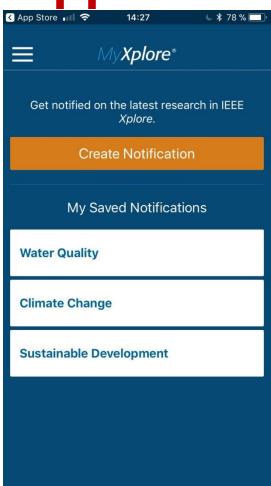


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Mobile alerts: MyXplore App











Publishing or Patenting?

Idea (No Idea)

Course work

Research

Publish /Patent

Career Dev



IEEE journal or IEEE conference?

IEEE Journals



 IEEE journals are cited 3 times more often in patent applications than other leading publisher's journals



A high percentage of articles submitted to any professional publication are rejected

IEEE Conferences

- IEEE Conference
 proceedings are recognized
 worldwide as the most vital
 collection of consolidated
 published articles in EE,
 computer science, related
 fields
- Per IEEE Policy, if you do not present your article at a conference, it may be suppressed in IEEE Xplore and not indexed in other databases



IEEE journal impact factor

22 of the top 25 journals in Electrical and Electronic Engineering

13 of the top 15 journals in Telecommunications

4 of the top 5 journals in Artificial Intelligence

4 of the top 5 journals in Computer Science, Information Systems

3 of the top 5 journals in Computer Science, Hardware & Architecture

3 of the top 5 journals in Automation & Control Systems

2 of the top 5 journals in Computer Science, Cybernetics

2 of the top 5 journals in Imaging Science & Photographic Technology





* Based on the Clarivate Analytics Journal Citation Report study released June 2017

** Source: 1790 Analytics

More info: www.ieee.org/citations and www.ieee.org/citations



JCR: Electrical and Electronic Engineering

- Progress in Quantum Electronics
- IEEE Transactions on Fuzzy Systems
- IEEE Signal Processing Magazine
- IEEE Transactions on Industrial Electronics
- IEEE Transactions on Pattern Analysis and Machine Intelligence
- Proceedings of the IEEE
- IEEE Industrial Electronics Magazine
- IEEE Communications Magazine
- IEEE Transactions on Power Electronics
- IEEE Transactions on Neural Networks and Learning Systems
- IEEE Wireless Communications Magazine
- IEEE/ASME Transactions on Mechatronics
- IEEE Transactions on Medical Imaging
- IEEE Transactions on Image Processing
- IEEE Transactions on Sustainable Energy
- IEEE Journal on Selected Areas in Communications
- Automatica
- IEEE Intelligent Systems
- IEEE Journal of Selected Topics in Quantum Electronics
- Pattern Recognition



2018 new journals

- IEEE Internet of Things
 Magazine
- IEEE Transactions on Medical Robotics and Bionics
- ■IEEE Letters of the Computer Society
- ■IEEE Solid-State Circuits
 Letters
- IEEE Control Systems Letters
 (First articles published mid 2017)
- **■IEEE Sensors** Letters

(First articles published mid 2017)

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2017 new journals

- ■IEEE **Communications Standards**Magazine
- ■IEEE Journal of **Electromagnetics**, RF and Microwaves in Medicine and Biology
- ■IEEE Trans. on Emerging Topics in Computational Intelligence
- ■IEEE Trans. on **Green Communications** and Networking
- ■IEEE Trans. on Radiation and **Plasma Medical Sciences**
- ■IEEE Journal of Radio Frequency Identification









Examples: Microware Theory and Techniques Society

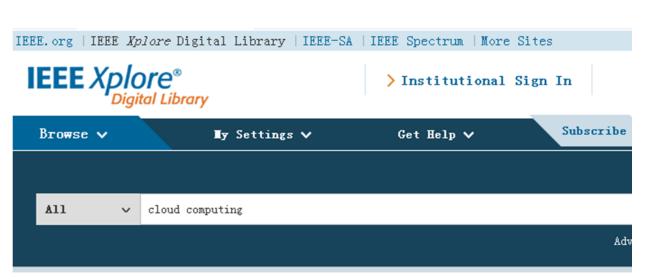
	Transactions	Letters	Magazine
NewResearch Article	YES(6pages, over-lengthcharge)	YES(3pages)	NO
TutorialArticle	YES(atexpert level)	NO	YES(atFundamental toIntermediatelevel)
Application Note	NO	NO	YES
ReviewArticle	YES(atexpert level)	NO	YES(atFundamental toIntermediatelevel)

- Research Article: Papers in the journals use the IEEE standard format and must include a Title, Abstract, Introduction, Technical Content, Conclusions, and References. The transactions also include the author biographies.
- **Tutorial:** Unique presentation of known material. Valuable methodologies, exhaustive references
- Application Note: Describe current application of technology: circuits, systems, models, concepts.
- **Review:** Historical account of field, exhaustive references, explanation of state-of-the-art,



future research

Journal/conference selection



Is content appropriate, in scope and level?

Publication Title ^

Enter Title

- Cloud Computing, IEEE Transactions on (434)
- Cloud Computing, IEEE (419)
- Cloud Computing and Intelligent Systems (CCIS), 2012 IEEE 2nd International Conference on (327)
- Parallel and Distributed
 Systems, IEEE Transactions
 on (293)
- Services Computing, IEEE
 Transactions on (240)

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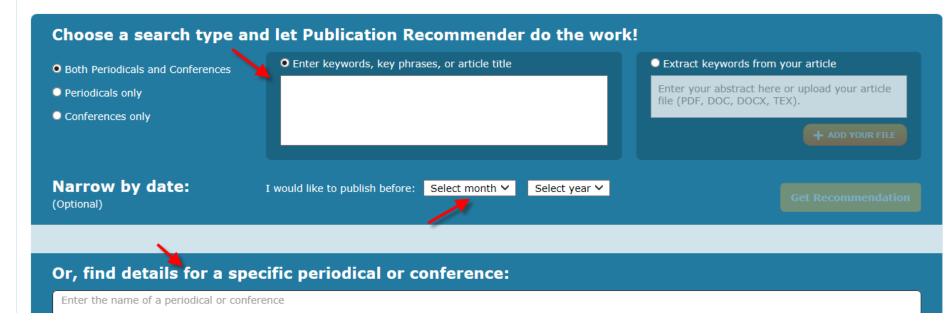
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- Editorial board
- IEEE Letters of the Co Submission guideline
 - Review criteria

IEEE TRANSACTIONS ON AFFECTIVE COMPUTING IEEE Transactions on Affective Computing²

Understanding, recognizing, and utilizing human emotions in computational systems.



IEEE Transactions on Cloud Computing

Announcements

- Heartfelt congratulations are offered to TCC's Editor-in-Chief Hui Lei, who received a 2017 IEEE Computer Society Technical
 Achievement Award "for pioneering contributions to scalable access to real-world data." Read more.
- Congratulations to Hui Lei on his appointment as 2016-2017 Editor-in-Chief of IEEE Transactions on Cloud Computing. Dr. Lei
 is CTO, Watson Health Cloud at IBM, where he provides leadership on the Watson Health Cloud technical strategy and
 spearheads the development of the Watson Health Cloud platform.
- Introduction to the IEEE Transactions on Cloud Computing by Rajkumar Buyya (PDF)
- · Welcome Message by Jon Rokne (PDF)

Editorials

- · TCC: State of the Transactions (Jan-March
- · IEEE Transactions on Cloud Computing: Er
- · A Status Report on IEEE Transactions on C

Guest Editorials

- · Special Issue on Green and Energy-Efficier
- Special Issue on Green and Energy-Efficier
- · Special Issue on Scientific Cloud Computin
- · Special Issue on Scientific Cloud Computin
- · Special Issue on Economics and Market Me
- · Cloud Security (Oct-Dec 2014)

Reviewers List

2016 TCC Reviewers List (PDF)

- 3) TCC has been regularly attracting a healthy number of submissions and as a result we are able to accept high quality papers and maintain a competitive acceptance rate. The details on submissions and acceptance during 2013 and 2014 are as follows:
 - 2013 submissions: 348 (including SI papers)
 - 2014 submissions: 725 (including SI papers)
 - Number of papers accepted in 2013: 51 = 14.6%
 - Number of papers accepted in 2014: 56 = 7.7%.
- Please note that not all papers submitted in 2014 are included in the acceptance statistics above as they

Author Index

· 2016 TCC Author Index (PDF)



TCC: State of the Transactions

Hui Lei, Fellow, IEEE

It has been a privilege and honor for me to serve as the Editor-in-Chief (EIC) of the IEEE Transactions on Cloud Computing (TCC). I am pleased to report that over the past

IEEE TRANSACTIONS ON CLOUD COMPUTING, VOL. 5, NO. 1, JANUARY-MARCH 207

2016 Reviewers List*

We thank the following reviewers for the time and energy they have given to TCC:

Α

Kannammal A Mohammad Aazam Martin Abadi Jemal Abawajy Zahra Abbasi Omer Abdelrahman Omar Abdul-Rahman Roiitha Abdulla Monir Abdullah Razzaque Abdur Mohammad Amr Abed Khalid Abed Luca Abeni Saeid Abolfazli Saeid Abrishami Sharkh Abu Mohamed Hussam Abu-Libdeh Eltayeb Abuelyaman Abdullah Abuhussein Utku Acer Gunay Giuseppe Aceto Shreenath Acharya

Carlisle Adams

Ryan Adams

Sasan Adibi

Olu Akin Kiumi Akingbehin Soramichi Akiyama Hidavet Aksu Osman Al Said Al Ahmed Al-Absi Mortada Al-Banna Auday Al-Dulaimy Mohammad Al-Fares Ala Al-fugaha Dhiya Al-Jumeily Samer Al-Kiswany Fadi Al-Turiman K Alam Ismail Alan Marwah Alansari Hamid Alasadi Moutaz Alazab Massimiliano Albanese Saleh Albelwi Abdulrahman Aldhaheri Zachary Alexander Mohammed Alhamid Mohannad Alhanahnah Amal Alhosban A Ali

Kiran Amin Salehi Amini Ahmed Amokrane Cristiana Amza Vishal Anand Arun Anandasivam Rachid Anane David Anderson Stefan Andrei Yiannis Andreopoulos Lachlan Andrew Vasilios Andrikopoulos Darko Androcec Elli Androulaki Artur Andrzejak Pelin Angin Dinh Anh S. Anithakumari Julio Anjos Alagan Anpalagan Nirwan Ansari Gabriel Antoniu Nuno Antunes Bernady Apduhan

Jonathan Appavoo

Varsha Apte

Henning Baars Seved Babamir Muhammad Babar Shivnath Babu Enzo Baccarelli Christian Bach Michael Backes Jean Bacon Rosa Badia Joonsang Baek Mohammad Baharloo Victor Bahl Mehdi Bahrami Ardeshir Bahreininejad Rami Bahsoon Xiaoving Bai Yan Bai Fabrizio Baiardi Peter Bailey Henri Bal Mahesh Balaji Pavan Balaji Janaka Balasooriya

Bharath Balasubramanian

Cyril Ballagny

We warmly welcome the above new members of the editorial board. They have brought with them deep expertise for the first time and required at least 65 percent new content. Since June 2016, we have reduced the requirement on new content to 33 percent, to encourage the submission of extended conference papers and to align with the practice of other IEEE transactions. We have also modified *TCC* policies to allow comments papers in addition to regular research papers. We hope such policy changes will provide more opportunities for idea exchange amongst members of the cloud computing community.

We have seen a steady growth of submissions to the journal. We have also taken measures to improve the paper review process. We have set explicit performance objectives, and have been closely monitoring the performance of the Associate Editors and reviewers and providing timely performance feedback. It is gratifying to see that our efforts have paid off. The average time from submission to first decision is 75 days in 2016, which represents over 20 percent reduction of the number for 2015. In order to improve the time from acceptance to publication, we have temporarily suspended taking new proposals for special issues. Further, we have substantially increased the total page budget for *TCC* in 2017.

We have continued to develop the TCC community. We have made arrangements with two key conferences in cloud computing—IEEE International on Cloud Engineering (IC2E) and IEEE International Conference on Cloud Computing Technology and Science (CloudCom), so that the best papers from these conferences can be recommended to TCC and fast-tracked in the TCC review process. In addition, these conferences have agreed to include special TCC sessions in their program for the presentation of papers to be published in TCC. These arrangements will

140

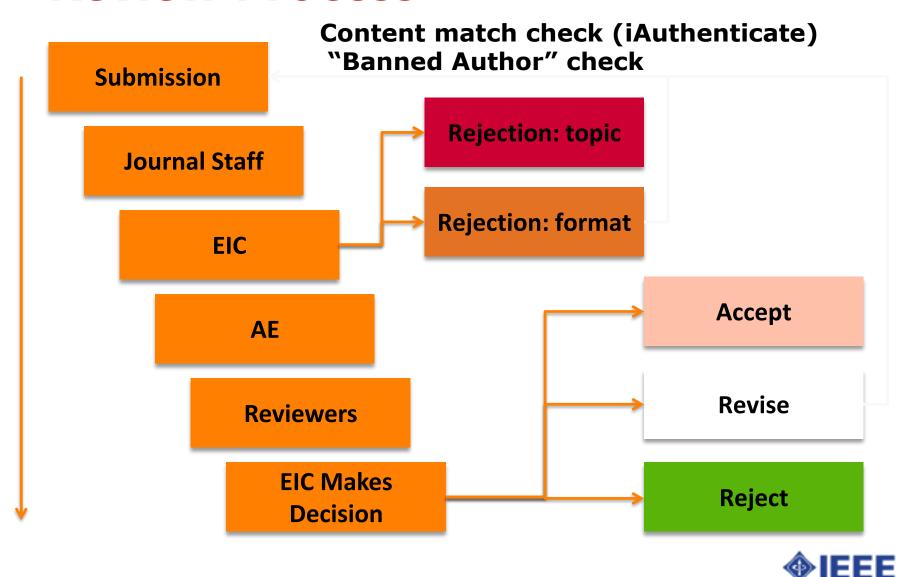
Finding Conference Calls for Papers

IEEE Conference Search Results Search Conferences Your search returned 907 Conferences for electron devices electron devices Select type & date range Conference Name ▲ ▼ Conference Date ▲ ▼ Location ▲ ▼ Conference date 2021 IEEE International Electron Devices Meeting (IEDM) 13 Dec - 15 Dec 2021 Hilton San Francisco Union Call for papers Sauare Abstract submission deadline: 01 Jun 2021 San Francisco, CA, USA From: Final submission deadline: 01 Sep 2021 В To: Notification of acceptance date: 01 Aug 2021 Location (optional) 2020 IEEE International Electron Devices Meeting (IEDM) Hilton San Francisco 10 Dec - 18 Dec 2020 Select an IEEE region San Francisco, CA, USA Select a country/region 2020 IEEE Symposium on VLSI Technology 16 Jun - 18 Jun 2020 TBD Select a country/region TBD, TBD, Afghanistan Albania Algeria 2019 IEEE International Electron Devices Meeting (IEDM) 09 Dec - 11 Dec 2019 Hilton San Francisco Union Andorra Sauare Angola Abstract submission deadline: 01 Jun 2019 San Francisco, CA, USA Anguilla Final submission deadline: 01 Sep 2019 Antiqua and Barbuda Notification of acceptance date: 01 Aug 2019 Argentina Armenia Aruba 2018 IEEE International Electron Devices Meeting (IEDM) Hilton San Francisco 29 Nov - 07 Dec 2018 San Francisco, CA, USA Austria Azerbaijan 2018 IEEE Symposium on VLSI Technology 12 Jun - 14 Jun 2018 TBD Bahamas Bahrain TBD, TBD, Bangladesh Barbados 2018 IEEE 30th International Symposium on Power 13 May - 17 May 2018 Palmer House Hilton Belarus Semiconductor Devices and IC's (ISPSD) 17 East Monroe Street Belgium Chicago, IL, USA Abstract submission deadline: 31 Oct 2017



Full Dance Submission deadlines 21 Mar 2019

Review Process



Why IEEE editors and reviewers reject papers

- The content is not a good fit for the publication
- There are serious scientific flaws:
 - Inconclusive results or incorrect interpretation
 - Fraudulent research
- It is poorly written
- It does not address a big enough problem or advance the scientific field
- The work was previously published
- The quality is not good enough for the journal
- Reviewers have misunderstood the article



Do &Don't

- Authorship (and Acknowledgements)
- Plagiarism
- Reuse of Published Materials
- Duplicate Submission
- Evolution of Research
- Fabrication or Falsification



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IEEE considers individuals who meet **all** of the following criteria to be authors:

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- Contributed to drafting the article or reviewing and/or revising it for intellectual content; and
- 3. Approved the final version of the article as accepted for publication, including references.

Contributors who do not meet all of the above criteria can be included in the Acknowledgement section of the article.



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- "Self-plagiarism" and conference paper republication are issues in some societies

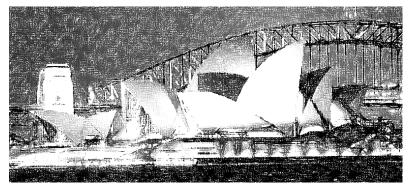


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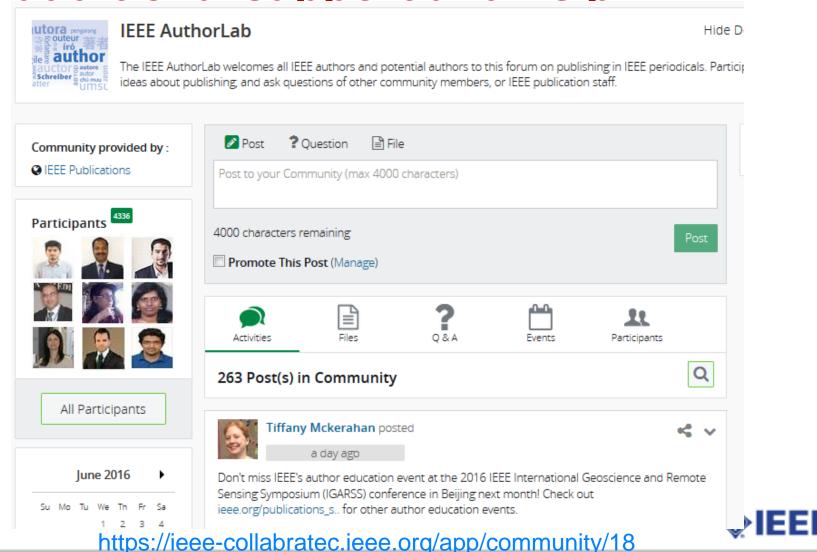
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Patenting first, then publishing

Idea (No Idea)

Course work

Research

Publish /Patent

Career Dev



Prior art searching before patenting



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Face recognition using modified deep learning neural network

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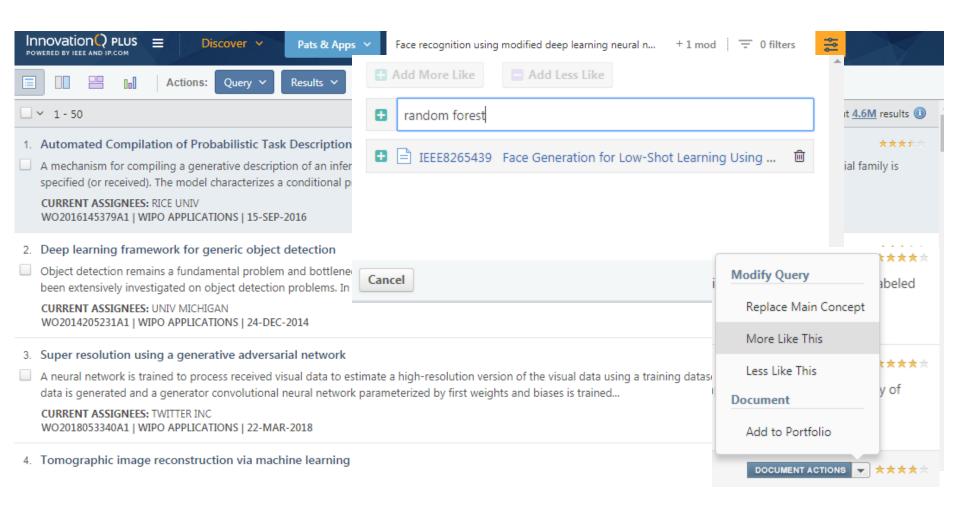
PATENTS & APPLICATI...

Face recognition using modified deep learning neural network Deep learning methods, especially convolutional neural networks have achieved significant success in the area of computer vision including the difficult face recognition problems. Training of deep models shows exceptional performance with large datasets, but they are not suitable for learning from few samples. This paper proposes a modified deep learning neural network to learn face representation from a smaller dataset. The proposed network is composed of a set of elaborately designed CNNs, RELUs and fully connected layers. The training dataset is augmented with synthetically generated samples by applying Gaussian and Poisson noise to each sample of the training set, thus doubling the size of the training set. We experimentally demonstrate that the augmented training dataset actually improves the generalization power of CNNs. The network is trained using the standard AT&T face





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Course work

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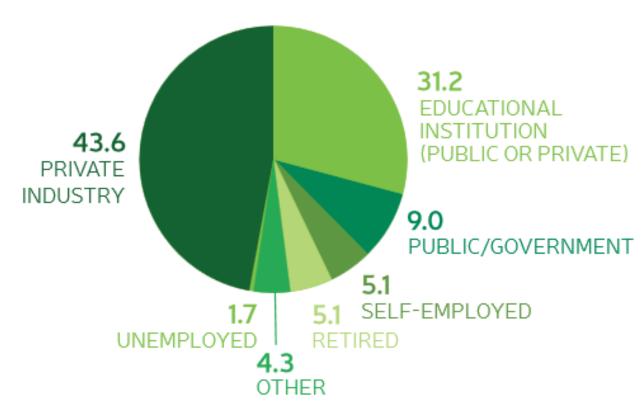
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Career Dev



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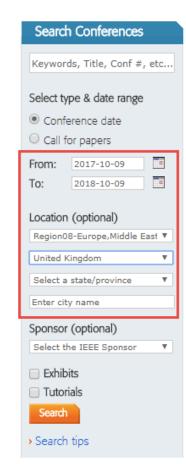


Networking the IEEE Way

- Involvement in IEEE Societies, Sections, and Chapters
 - Local Section activities
 - National and international activities
- Participation in IEEE Young Professionals Program and Women in Engineering groups
- ~1,700+ IEEE conferences per year
 - Great locations for face-to-face networking!
 - Opportunity to present papers or engage in poster sessions
 - http://www.ieee.org/conferences_events/index.html
- Social Networking: IEEE Collabratec, IEEE MemberNet, LinkedIn, Facebook and Twitter



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2018 Embedded Systems Week (ESWeek)

Abstract submission deadline: 01 Apr 2018 Final submission deadline: 07 Jul 2018

2018 IEEE/RSJ International Conference on Interpacts (ARSO)

Abstract submission deadline: 15 Mar 2018 Final submission deadline: 15 Mar 2018

2018 IEEE/RSJ International Conference on Interpacts (ARSO)

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Full Paper Submission deadline: 15 Mar 2018

Full Paper Submission deadline: 15 Mar 2018

Full Paper Submission deadline: 01 Jul 2017

Notification of acceptance date: 15 Jun 2018

2018 IEEE International Conference on Soft Maintenance and Evolution (ICSME)

2018 Embedded Systems Week (ESWeek)
Abstract submission deadline: 25 Mar 2018

Full Paper Submission deadline: 01 Apr 2018 Final submission deadline: 07 Jul 2018 Notification of acceptance date: 23 Jun 2018

2018 IEEE Workshop on Advanced Robotics and Impacts (ARSO)

Abstract submission deadline: 15 Mar 2018 Full Paper Submission deadline: 15 Mar 2018 Final submission deadline: 01 Jul 2017

Conference Name * * Conference Date * * Location + * 2018 25th IEEE International Conference on Image 07 Oct - 10 Oct 2018 Megaron Athens Processing (ICIP) International Conference Centre (MAICC) Vass. Sofias & Kokkali Athens, Greece 2018 IEEE/RSJ International Conference on Intelligent Palacio Municipal de 01 Oct - 05 Oct 2018 Robots and Systems (IROS) Congresos Avenida Capital de Espana. Full Paper Submission deadline: 01 Mar 2018 Notification of acceptance date: 15 Jun 2018 Madrid, Spain 30 Sep - 05 Oct 2018 Centro Congressi Lingotto Via Nizza 280 Abstract submission deadline: 25 Mar 2018 Torino, Italy Full Paner Submission deadline: 01 Apr 2018 Final submission deadline: 07 Jul 2018 Notification of acceptance date: 23 Jun 2018 2018 IEEE Workshop on Advanced Robotics and its Social 27 Sep - 29 Sep 2018 Palazzo della Borsa Impacts (ARSO) via XX Settembre, 44 Genova Italy Abstract submission deadline: 15 Mar 2018 Full Paper Submission deadline: 15 Mar 2018 Final submission deadline: 01 Jul 2017 Notification of acceptance date: 01 Jun 2018 2018 IEEE International Conference on Software 25 Sep - 27 Sep 2018 Maintenance and Evolution (ICSME) Madrid, Spain 2018 IEEE/AIAA 37th Digital Avionics Systems Conference 23 Sep - 27 Sep 2018 IBIS London Earl's Court (DASC) United Kingdom 2018 7th Electronic System-Integration Technology 18 Sep - 21 Sep 2018 Westin Bellevue Hotel and Conference Center Dresden Conference (ESTC) Dresden, Germany Abstract submission deadline: 31 Jan 2018 Final submission deadline: 30 Jun 2018. Notification of acceptance date: 15 Mar 2018 2018 20th European Conference on Power Electronics and 17 Sep - 21 Sep 2018 Kinsala International Applications (EPE'18 ECCE Europe) Exhibition Centre Latvia Abstract submission deadline: 15 Nov 2017 Final submission deadline: 01 Jun 2018 Notification of acceptance date: 01 Mar 2018 2018 IEEE International Conference on Vehicular Electronics 12 Sep - 14 Sep 2018 UC3M Campus Puerta de and Safety (ICVES) Toledo Ronda de Toledo 1 Madrid, Spain 2018 IEEE International Conference on Cluster Computing 10 Sep - 14 Sep 2018 Belfast Assembly Buildings (CLUSTER) Conference Centre 2-10 Fisherwick Place Abstract submission deadline: 04 May 2018 Belfast, United Kingdom



Full Paper Submission deadline: 18 May 2018 Notification of acceptance date: 06 Jul 2018

IEEE Student Branch

The IEEE Student Branch is an operating organizational unit of IEEE at the college/university level constituted by a minimum of twelve (12) IEEE student members

- Goal: Engage students in the mission, benefits, and opportunities of the IEEE
- Sponsors activities and events with technical, professional, and humanitarian aspirations
 - Guest speakers
 - Paper contests
 - Local community initiatives
- Fun, too!
 - Social events to bring together students with faculty
 - PI Day





IEEE Student Branches in Taiwan

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Commitment to standards education



IEEE is committed to:

promoting the importance of standards in meeting technical, economic, environmental, and societal challenges;

disseminating learning materials on the application of standards in the design and development aspects of educational programs;

- actively promoting the integration of standards into academic programs;
- providing short courses about standards needed in the design and development phases of professional practice.

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Resources

"If you control an industry' s standards, you control it lock, stock and ledger."

"Standardization programs offer one of the best, most important means to evaluate current technology and provide a glimpse of where future technology innovations may occur.

The Strategic Value of Standards Education
A Global Survey conducted by
the Center for Global Standards Analysis



Scholarships, Grants, and Fellowships

http://www.ieee.org/membership services/membership/students/awards/sag.html

Scholarships, grants, and fellowshi

IEEE Charles LeGeyt Fortescue Fellowship: This so approximately US\$24,000 and is awarded to a first-year master's degree in Electrical Engineering at an engineer located in the United States.

IEEE Computational Intelligence Society Conference a number of travel grants to assist IEEE Student meml (Neural Networks Society) sponsored conferences.

IEEE Computational Intelligence Society Summer scholarships of US\$1,000 to US\$4,000 for deserving gr support for their research during a summer period.

IEEE Computer Society Merwin Scholarship: This sactive leaders in the IEEE Computer Society Student Escholarships are available and awarded on an annual b

IEEE Dielectrics and Electrical Insulation Society (fellowship was designed to support graduate research in Two US\$7,500 or three US\$5,000 scholarships are away

IEEE Electron Devices Society Graduate Student F recognizes, and supports graduate-level study and rese fellowship awarded to students in each of the main ged Europe/Mid-East/Africa, Asia/Pacific.

IEEE James C. Klouda Memorial Scholarship Awa Memorial Scholarship awards a scholarship to a qualifi an electrical engineering degree with emphasis in the f a related discipline, from an accredited US university o IEEE Life Members' Fellowship in Electrical History: This fellowship in Electrical History supports either one year of full-time graduate work in the history of electrical science and technology at a college or university of recognized standing, or up to one year of post-doctoral research for a scholar in this field who has received his or her Ph.D. within the past three years. The stipend is US\$17,000, and a research budget of US\$3,000 is available.

IEEE Life Member Graduate Study Fellowship in Electrical Engineering: This renewable US\$10,000 fellowship is awarded annually to a first-year, full-time graduate student obtaining his or her master's degree for work in the area of electrical engineering, at an engineering school/program of recognized standing worldwide.

IEEE Masters Student Fellowship: This one-year fellowship is awarded to promote, recognize, and support graduate masters-level study and research within the Electron Devices Society's field of interest. The prize is US\$2,000 and a plaque to the student, to be presented by the dean or department head of the student's enrolled graduate program.

IEEE Microwave Theory and Techniques Society Graduate Fellowships: This program was created to support graduate research studies in microwave engineering. Fellowships are in the amount of US\$5,000 each, and the deadline for submission is 30 November annually.

IEEE Nuclear and Plasma Sciences Society Graduate Scholarship Award: This scholarship recognizes contributions to the fields of nuclear and plasma sciences. Scholarships are in the amount of US\$500 and are awarded annually, with submission deadline on 31 January.

IEEE Photonics Society Graduate Student Fellowship Program: This fellowship program provides ten fellowships of US\$5,000 each. They will be awarded based on the student membership in each of the main geographic regions: Americas, Europe/Mid-East/Africa, Asia/Pacific.

IEEE Power and Energy Society Scholarship Program: This program is being offered for the second year with scholarships to students. The prize is US\$2,000 and a plaque to the student, to be presented by the Dean or Department head of the student's enrolled graduate program.

Student Travel grants

IEEE Student Travel Grants

IEEE Students

IEEE is pleased to offer a number of Student Travel Grants to assist Student

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Student Progr **Highlights**

IEEE is pleased to offer a number of Student Travel Grants to assist Student Members in attending conferences and presenting papers. Additional student ■ Student Comp grant opportunities may be found by visiting an IEEE Conference Web site(s) matching your technical interest.

Student Schol

- IFFF Potentials Magazine
- Student Member Benefits

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Student Volunteer Resources



> IEEE Circuits and Systems Society

- IEEE Computational Intelligence Society
- > IEEE Communications Society
- IEEE Engineering in Medicine and Biology Society

- IEEE Industry Applications Society
- > IEEE Information Theory Society
- > IEEE Instrumentation & Measurement Society
- > IEEE Microwave Theory and Techniques Society

> IEEE Nuclear and Plasma Sciences Society

Below are some of the grants offered by IEEE

only. To apply, you will need to follow the

Societies that are designated for Student Members

appropriate link to obtain eligibility and applications.

- > IEEE Power Electronics Society
- > IEEE Signal Processing Society
- IEEE Solid-State Circuits Society





Place	Country		Team Name
1		Iceland	viRUs
2		USA	WhySoConcrete
3		Sri Lanka	oops

IEEE.tv ANNOUNCEMENT: http://goo.gl/Du8993

2014 Competition Stats

- 2,288 teams registered
 - 5,900 students; 600 proctors; 100 volunteers/staff
- 63 countries and 480 universities represented
- More than 320,000 solutions submitted
- Expanded committee includes Public Relations Ambassadors

24 October 2015

0:00:00 GMT - 23:59:59 GMT









Business and Leadership Model

- Adopted new business model towards cost containment
- Provided digital gift bundle to all participants and tangible prize bundle to top 100 teams
- Planning move from ad-hoc to standing subcommittee of SAC and adoption of proven infrastructure to ensure future success

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